Attorney Docket No. 5649-968

<u>PATENT</u>

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.

Group Art Unit: 2829

Serial No.: 10/046,805

Examiner: Lisa A. Kilday

Filed: January 14, 2002

Confirmation No.: 6423

METHODS OF FORMING METAL LAYERS IN INTEGRATED CIRCUIT

DEVICES USING SELECTIVE ELECTROPLATING ON EDGES OF

RECESSES AND CONDUCTIVE CONTACTS SO FORMED

January 9, 2004

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## AMENDMENT AND SUBMISSION OF TERMINAL DISCLAIMER WITH INFORMATION DISCLOSURE STATEMENT

Sir:

This Amendment and Submission is responsive to the Official Action of July 9, 2003.

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.